

May 12, 2006

SUMCO CORPORATION

Public Relations & IR Dept
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**SUMCO Announced the Signing of New Plant Site Agreement
with Saga Prefecture**

SUMCO CORPORATION (hereinafter "SUMCO") announced that SUMCO signed with both Saga prefectural government and Imari municipal government an agreement regarding a new 300mm silicon wafer plant site in Imari Industrial Park at yesterday's ceremony attended by the Governor of Saga prefecture, Mr. Furukawa and the Mayor of Imari city, Mr. Tsukabe and SUMCO president Kenziro Shigematsu.

SUMCO's objective is to meet the rapidly growing demand of 300mm silicon wafer. With the conclusion of this agreement, SUMCO will undergo necessary official proceedings to move further with the undermentioned plan currently under study.

Plan under Study

■ Location	Yamashiro-cho, Imari-City, Saga Prefecture, Japan
■ Site area	Approx. 270,000m ²
■ Phase 1	
• Startup of Construction	July, 2006
• Startup of Operation	April, 2008
• Building area	Approx. 24,180m ²
• Total floor area	Approx. 75,000m ²
• Construction	Three-storied steel-frame construction
• Production capacity	Approx. 100,000 sheets per month

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